Low Power Consumption Micro C2H5OH Gas Sensor based on Micro-heater and Screen Printing Technique

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Abstract
Micro C2H5OH gas sensor was fabricated based on micro-heater using tin oxide nano-powders with low power consumption and high sensitivity. Semiconducting SnO2 nano-powders were synthesized via co-precipitation method, and to increase the sensitivity for alcohol gas rare metal dopants were added. In the structure of micro-heater, the resistances of two semi-circled Pt heaters are connected to the spreader for thermal uniformity. Based on the above design, low power consumption alcohol gas sensor was fabricated by using CMOS compatible MEMS process. Bridge type micro-heater based on Si substrate was fabricated by surface micromachining technique. Micro gas sensor showed substantial sensitivity down to 0.5 ppm alcohol at low power consumption (35 mW).

Key words: gas sensor, SnO2, micro-heater, surface micromachining, alcohol

Introduction
Oxide semiconductors based gas sensors have been studied for several applications in detecting inflammable, toxic, and odorless gases. Moreover to reduce the power consumption of the device, the micro-heater to enhance the sensing and desorption of the target gas has been normally adopted [1-7].

In the group of hazardous gases, C2H5OH sensor is being focused to detect drunk driving or to detect leak in fuel cell. An extensive research is being carried out using various metal oxides like SnO2, ZnO, TiO2, WO3, In2O3, LaFeO3 as sensor materials [8-15]. Due to the difficulties in MEMS design, fabrication technique and higher production cost for micro gas sensor, few commercial devices based on bulk micromachining technique are selling by pioneering company. This technology needs further improvement in handling device wafer and cost reduction for dry Si etching technique [16-24].

In this study we report surface micromachined gas sensors based on the SnO2 thick film and micro-heater, which show low power consumption and high sensitivity for C2H5OH detection. The fabrication process for the micro gas sensor was based on the conventional complementary metal semiconductor (CMOS) compatible micro electro mechanical systems (MEMS) processes for mass-production, which is possible to integrate with other devices and electronic circuitry.

Experimental
Semiconducting SnO2 nano-powders were synthesized by homogeneous co-precipitation method. NH4OH solution was slowly added to the aqueous solution of SnCl4.5H2O to control the pH value of the solutions, which is one of main parameters to determine the characteristics of nano-powders. And to suppress the growth of crystal in sintering process or to activate the reaction to the C2H5OH, other materials based on rare metals were added with constant stirring. The resulting gel was washed several times with the de-ionised water in order to remove the excess Cl- and NH4+ ions. The final milky white gel (precipitate) was then dried at 100 °C for 24 h. The obtained white powder was calcinated at 600 °C for 1 h.

The bulk X-ray diffraction (XRD) analysis of the powder was carried out for the Bragg angle (2θ) from 10 to 60° using Cu Kα radiations. The average grain size of the powder was calculated using Scherrer formula

\[ D = 0.9 / (\beta \cos \theta) \]

where D is the average grain size, \( \lambda \) is the wavelength of the X-ray radiation used and \( \beta \) is...
the angular width of the diffracted peak at the half maximum (FWHM) for the diffraction angle \(2\theta\). In addition, further information about the particles size and shape was obtained by using scanning electron microscope (SEM). For SEM analysis, a thin conducting Pt layer (thickness 1–2 nm) was coated by using DC sputter.

To activate the gas sensing properties and to lessen the power consumption of the sensor, Si-based micro-heater was adapted, which was fabricated by using CMOS compatible MEMS processes. On these substrates SnO\(_2\) nano-powders were deposited by screen printing technique.

Gas sensing properties were measured using a computer-controlled characterization system. The resistances of the sensor materials upon the Si micromachined micro-heater were measured. The response, \(R\), is given by the rate of change in the resistance to the initial resistance, \(R = \Delta R/R_0 = |R_g - R_0|/R_0\), where \(R_g\) and \(R_0\) are the resistance in the test gas and in air, respectively.

**Results and Discussion**

Fig. 1 shows the XRD patterns of the doped SnO\(_2\) nano-powders. All peaks belong to SnO\(_2\) phase except one, which corresponds to Sn\(_2\)O\(_3\) phase. The calculated average grain size of the SnO\(_2\) nano-powders using Scherrer formula was 57±6 nm, which grain size was proper to detect gas.

In the structure of the micro-heater, the resistances of two semi-circular Pt heaters are connected to the track for power supply. The resistance of each heating element becomes an electrically equal Wheatstone-bridge, which is divided in half by the heat-spreading structure.

The generated heat diffuses from the circled heating elements through the heat spreaders to promote thermal uniformity at the central area where the sensing material will be located, which is thermally isolated by air using a bridge structure. The power consumption of the micro-heater device was simulated using the commercial finite element method (FEM) software (COMSOL). In the simulation, 400 °C temperature and the uniform thermal distribution at the center of the micro-heater were obtained in the expansive of 10 mW power consumption as shown in Fig. 3.

**Fig. 1.** XRD patterns of tin oxide nano-powders. * corresponds to the Sn\(_2\)O\(_3\) phase.

**Fig. 2.** (a) SEM image and (b) EDAX analysis result of tin oxide nano-powders.

**Fig. 3.** Temperature distribution of micro-heater with 10 mW power consumption by using commercial finite element method simulation software.
The low power consumption micro-heater was fabricated through a CMOS compatible MEMS processes, which was designed to endure high stress and to facilitate the fabrication processes. The detailed fabrication processes are shown in Fig. 4 with cross sectional schematic diagram and device picture after process. The thicknesses of the SiO₂ and the Si₃N₄ layer were determined to eliminate the residual tensile or compressive stress. The heating electrode and sensing electrode were patterned using a conventional lift-off process. The dry Si etching process with XeF₂ gas after sensing material deposition was the last step in the micro gas sensor fabrication process. Because the Si dry etching process using the XeF₂ gas did not damage the metal oxide thick film formed by the screen printing method, all the device fabrication processes were based on 6 inch Si substrate and were CMOS-compatible.

![Fabrication processes for C₂H₅OH gas sensor by using CMOS compatible MEMS process](image)

To investigate the power consumption characteristics of the micro-heater, the temperature-dependent resistance of the micro-heater was measured using four-wire resistance measurement method. The measured temperature-dependent resistance values were compared with the values that can be calculated in the applied operation power to the micro-heater. Fig. 5 shows that the power consumption of the micro-heater was approximately linear characteristic to the operation temperature, and that a 450 °C temperature was attained at the expense of about 15 mW power consumption.

![Power consumption characteristics of surface micromachined micro-heater](image)

A photograph of the packaged micro gas sensor based on metal oxide thick film is shown in the Fig. 6. In the C₂H₅OH gas sensor in TO-5 can package, gold wires were wire-bonded between the Pt metal pad in the gas sensor and the pad in the TO-5 can for the necessary electrical connections. In the enlarged SEM image of the micro gas sensor, square shaped sensing SnO₂ thick film exist in the center of O/N/O bridge in the square shaped surface micromachined Si etching area, where heating element exist inside, by using 4 opened square Si area.

![Packaged C₂H₅OH gas sensor (left) and enlarged SEM image of the sensor](image)

As shown in Fig. 7, SnO₂ nano-powders (generally n-type semiconductor) devices showed a conductance decrease at different concentrations of 0.5 to 2 ppm C₂H₅OH gas and the sensing response increased with an increasing C₂H₅OH concentration. The flow time of the target gas was 30 seconds, the response was nearly saturated for all the concentrations, and the initial resistance was recovered after the air gas was purged. The power consumption of the sensor was about 35 mW, which is much lower than that of the commercial semiconducting gas sensor [25]. The sensor device showed response (R) values of about 0.68 and 0.78 for 0.5 and 2 ppm C₂H₅OH, respectively. The measured power consumption of the micro gas sensor was much higher than that of the micro-heater, and it can be attributed to the thermal mass of the gas detection materials.
Summary

Micro C$_2$H$_5$OH gas sensor was fabricated based on micro-heater using tin oxide nanopowders with low power consumption and high sensitivity. The device was fabricated by using CMOS compatible MEMS process and the sensing material was deposited by using screen printing technique. Micro gas sensor showed substantial sensitivity down to 0.5 ppm alcohol at low power consumption (35 mW).

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References